NOTICE: Where tin coated circuitry exists a small percentage of the holes may have solder blockage. This is usually a light "skin" easily penetrated by component leads. In some cases, a soldering iron may be required.

CAUTION: IN ANY PLUG CONTACT AREA ON EITHER SIDE OF PLUGBORD, USE ONLY THOSE HOLES HAVING PADS. HOLES WITHOUT PADS MAY HAVE INSUFFICIENT CLEARANCE TO ADJACENT CIRCUITRY AND USING THEM COULD CAUSE SHORTING.

6. INTENDED FOR USE IN NON-HOSTILE ENVIRONMENTS UP TO 200 VOLS RMS OR 300 VOLS DC.
5. RECOMMENDED LOCATION FOR 146-4 TERMINALS IN POWER AND GROUND PLANES AT ROWS 23 & 25, AND LEFT SIDE REGULATOR POSITION.
4. ZIG-ZAG BUS PADS ON POWER PLANE ARE OFFSET FROM THOSE ON GROUND PLANE
3. DASHED CIRCLES REPRESENT CONNECTOR CONTACT PADS ON OPPOSITE SIDE OF BOARD
2. DIPS WITH 0.3" SPAN MOUNT OVER SOLID BUS COLUMNS

NOTES: 1. ZONE LETTERS A TO D ON LEFT BORDER, AND J TO Z ON TOP BORDER ARE DIP ROW & COLUMN DESIGNATORS
NOTICE: Where tin coated circuitry exists a small percentage of the holes may have solder blockage. This is usually a light "skin" easily penetrated by component leads. In some cases, a soldering iron may be required.

CAUTION: In any plug contact area on either side of plugboard, use only those holes having pads. Holes without pads may have insufficient clearance to adjacent circuitry and using them could cause shorting.

6. INTENDED FOR USE IN NON-HOSTILE ENVIRONMENTS UP TO 200 VOLTS RMS OR 300 VOLTS DC.
5. RECOMMENDED LOCATION FOR T46-4 TERMINALS IN POWER AND GROUND PLANES AT ROWS 23 & 25, AND RIGHT SIDE REGULATOR POSITION.
4. ZIG-ZAG BUS PADS ON POWER PLANE ARE OFFSET FROM THOSE ON GROUND PLANE
3. DASHED CIRCLES REPRESENT CONNECTOR CONTACT PADS ON OPPOSITE SIDE OF BOARD
2. DIPS WITH 0.3" SPAN MOUNT OVER SOLID BUS COLUMNS

NOTES: 1. ZONE LETTERS A TO D ON LEFT BORDER, AND J TO Z ON TOP BORDER ARE DIP ROW & COLUMN DESIGNATORS